

Fujitsu Microelectronics Announces Executive Appointments

Tokyo, March 21, 2008 - Following its establishment today, Fujitsu Microelectronics Limited announced the following executive appointments approved at its Shareholders' Meeting and Board of Directors meeting.

| Name | Title |
|------------------|---|
| Toshihiko Ono | President |
| Shigeru Fujii | Corporate Senior Executive Vice President |
| Koichi Ishizaka | Corporate Senior Vice President |
| Haruyoshi Yagi | Corporate Vice President |
| Joji Murakami | Corporate Vice President |
| Hiroyuki Hojo | Corporate Vice President |
| Hideo Monma | Corporate Vice President |
| Yoji Hino | Corporate Vice President |
| Michael F.Y.Shih | Corporate Vice President |
| Yasuo Nishiguchi | Corporate Vice President (part-time) |
| Haruki Okada | Corporate Vice President (part-time) |
| Masami Yamamoto | Corporate Vice President (part-time) |
| Yoshihiro Ando | Auditor |
| Masamichi Ogura | Auditor (part-time) |
| Toshimasa Wada | Auditor (part-time) |

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Inquiries

<https://www-s.fujitsu.com/global/news/contacts/inquiries/index.html>

About Fujitsu Microelectronics (FML)

Fujitsu Microelectronics Limited designs and manufactures semiconductors, providing highly reliable, optimal solutions and support to meet the varying needs of its customers. Products and services include ASICs/COT, ASSPs, power management ICs, and flash microcontrollers, with wide-ranging expertise focusing on imaging, wireless, automotive and security applications. Fujitsu Microelectronics also drives power efficiency and environmental initiatives. Headquartered in Tokyo, Fujitsu Microelectronics Limited was established as a subsidiary of Fujitsu Limited on March 21, 2008. Through its global sales and development network, with sites in Japan and throughout Asia, Europe, and the Americas, Fujitsu Microelectronics offers semiconductor solutions to the global marketplace. For more information: <http://jp.fujitsu.com/group/fml/en/>

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